

Applications

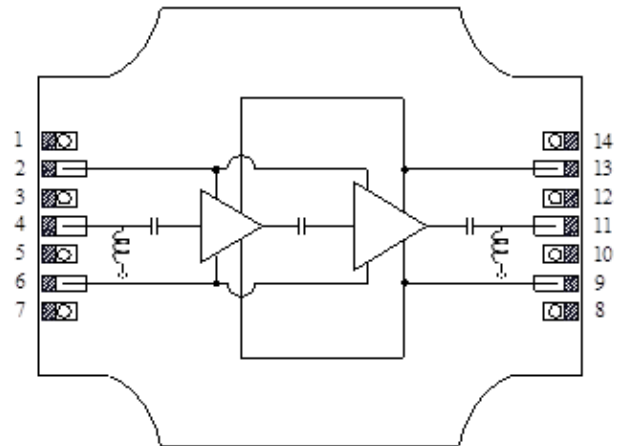
- Electronic Warfare
- Radar
- Test Instrumentation
- EMC Amplifier



Product Features

- Frequency Range: 2.5 to 6 GHz
- P_{SAT} : 46.5 dBm @ $P_{IN} = 26$ dBm
- PAE: 35%
- Small Signal Gain: 29 dB
- Bias: Pulse $V_D = 30$ V, $I_{DQ} = 1.55$ A, $V_G = -2.4$ V Typ
Pulse: PW = 150 us, DC = 5%
- Dimensions: 12.7 x 12.7 x 3.89 mm

Functional Block Diagram



General Description

TriQuint's TGA2576-FS is a packaged wideband power amplifier designed on TriQuint's production 0.25 um GaN on SiC process. Operating from 2.5 to 6 GHz, the TGA2576-FS achieves 40 W of saturated output power, greater than 35% power-added efficiency and 29 dB small signal gain.

Both RF ports are fully matched to 50 Ω , the TGA2576-FS is ideally suited to support both commercial and defense related opportunities.

Lead-free and RoHS compliant

Evaluation Boards are available up on request.

Pin Configuration

Pin No.	Symbol
1, 3, 5, 7, 8, 10, 12, 14	GND
2, 6	V_G
4	RF_{IN}
9, 13	V_D
11	RF_{OUT}

Ordering Information

Part	ECCN	Description
TGA2576-FS	3A001.b.2.a	2.5 to 6 GHz 40W GaN PA

Absolute Maximum Ratings

Parameter	Value
Drain Voltage (V_D)	40 V
Gate Voltage (V_G)	-5 to 0 V
Drain Current (I_D)	5000 mA
Gate Current (I_G)	-18 to 35 mA
Power Dissipation ($P_{DISS, Pulse}$)	120 W
RF Input Power, CW, 50 Ω , T = 25°C	28 dBm
Channel temperature (T_{CH})	275°C
Mounting Temperature (30 Seconds)	260°C
Storage Temperature	-40 to 150°C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value
Drain Voltage (V_D), Pulsed: PW = 150 us, DC = 5%; not recommend for CW	30 V
Drain Current (I_{DQ})	1550 mA
Drain Current Under RF Drive (I_{D_DRIVE})	see plots p. 8
Gate Voltage (V_G)	-2.4 V Typical
Temperature backside package (T_{BASE})	-40 °C to \leq 85 °C (see T_{BASE} derating plots p.3 & p.4)

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25°C, $V_D = 30$ V, $I_{DQ} = 1550$ mA, Pulsed: PW = 150 us, DC = 5%, $V_G = -2.4$ V Typical; not recommend for CW

Parameter	Min	Typical	Max	Units
Operational Frequency Range	2.5		6	GHz
Small Signal Gain		29		dB
Input Return Loss		15		dB
Output Return Loss		10		dB
Output Power @ Saturation ($P_{in} = 26$ dBm)		46.5		dBm
Power-Added Efficiency ($P_{in} = 26$ dBm)		35		%
IM3 @ $P_{out}/Tone = 36$ dBm		-15		dBc
IM5 @ $P_{out}/Tone = 36$ dBm		-30		dBc
Small Signal Gain Temperature Coefficient		-0.05		dB/°C
Output Power Temperature Coefficient		-0.01		dBm/°C

Thermal and Reliability Information

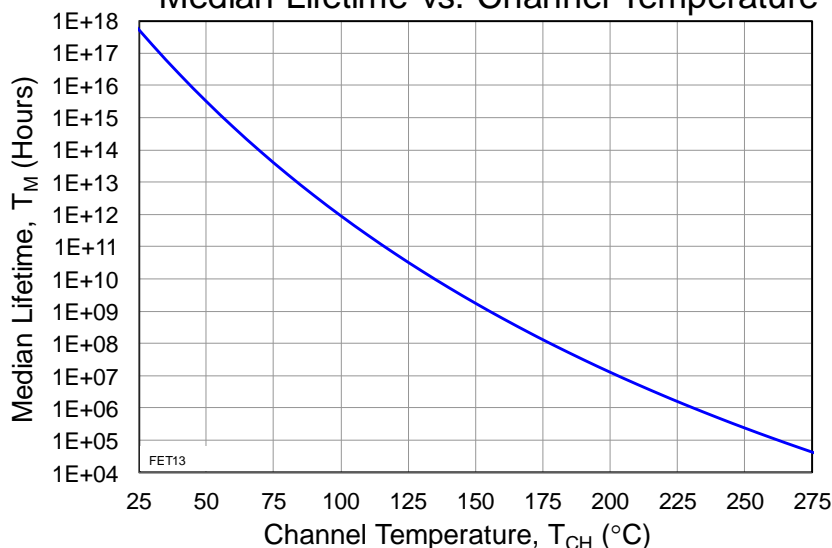
Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{BASE} = 85^{\circ}C$, $V_D = 30$ V Pulse PW = 150 us, DC = 10 %	1.31	$^{\circ}C/W$
Channel Temperature (T_{CH})	Freq = 4 GHz, $P_{IN} = 26$ dBm: $I_{DQ} = 1.5$ A, $I_{D Drive} = 3.8$ A $P_{OUT} = 46$ dBm	182	$^{\circ}C$
Median Lifetime (T_M)	$P_{DISS} = 74$ W	6.6×10^7	Hours

Notes:

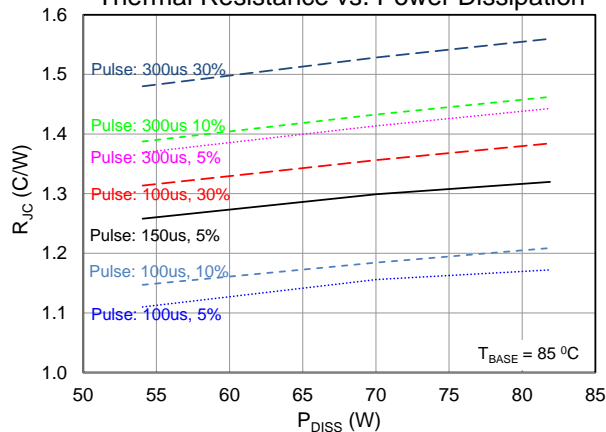
1. Measured junction to package backside.

Test Conditions: $V_D = 40V$; Failure Criteria is 10% reduction in $I_{D MAX}$

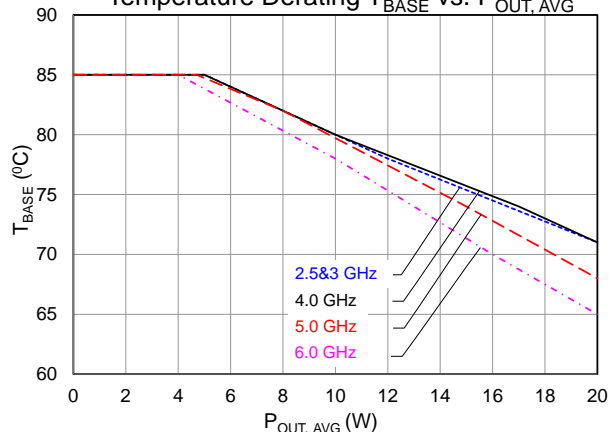
Median Lifetime vs. Channel Temperature



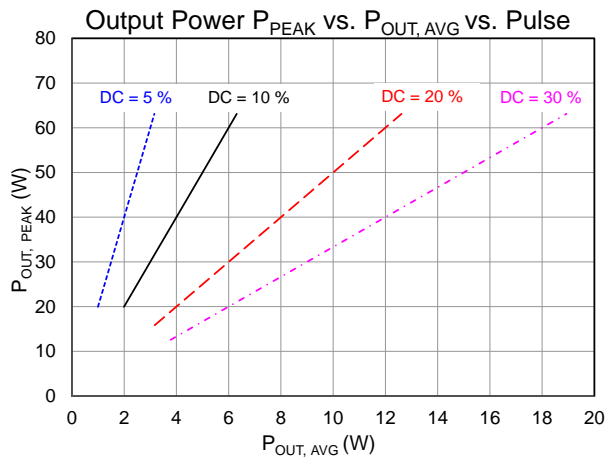
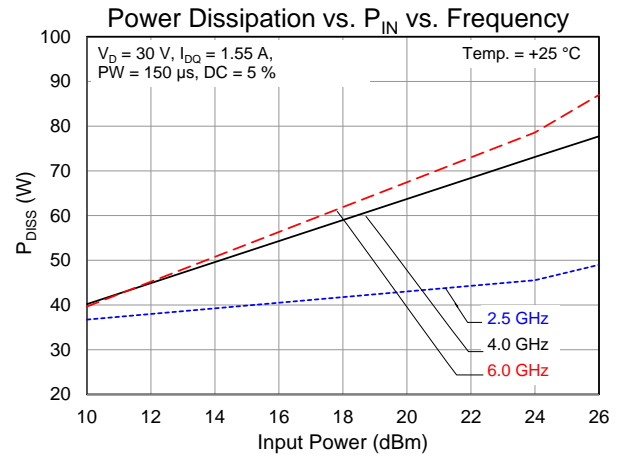
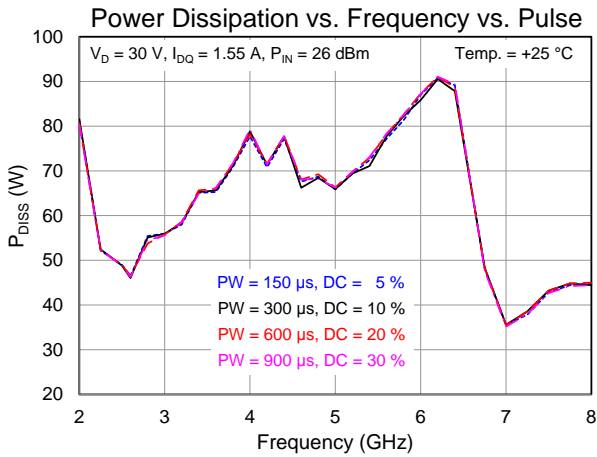
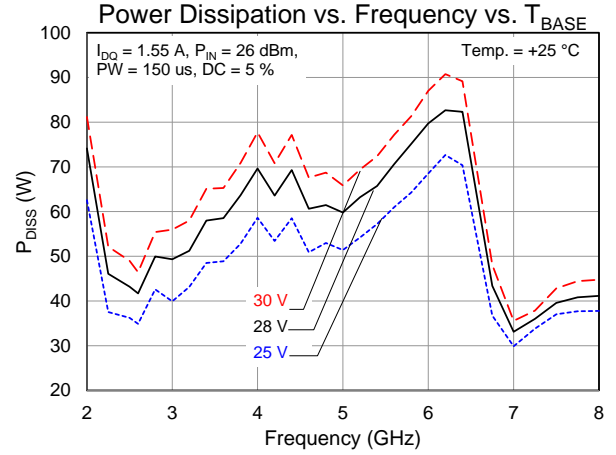
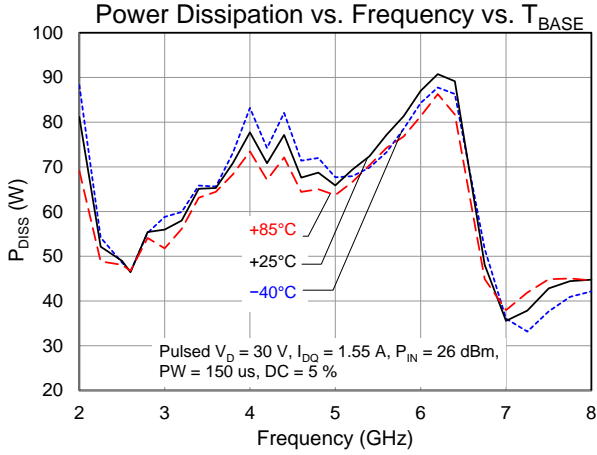
Thermal Resistance vs. Power Dissipation



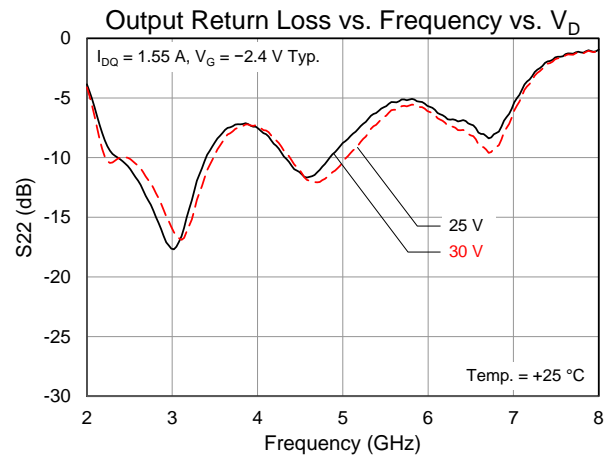
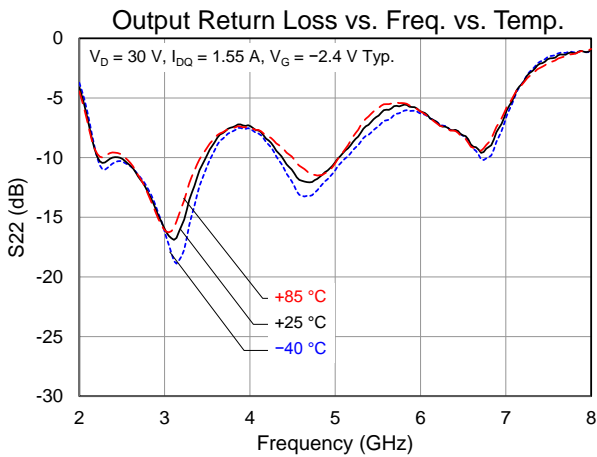
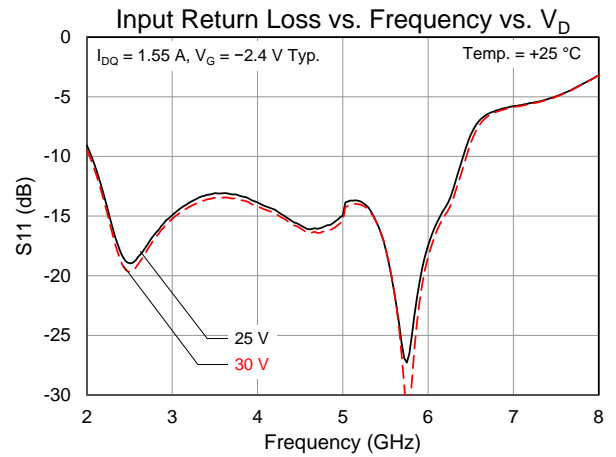
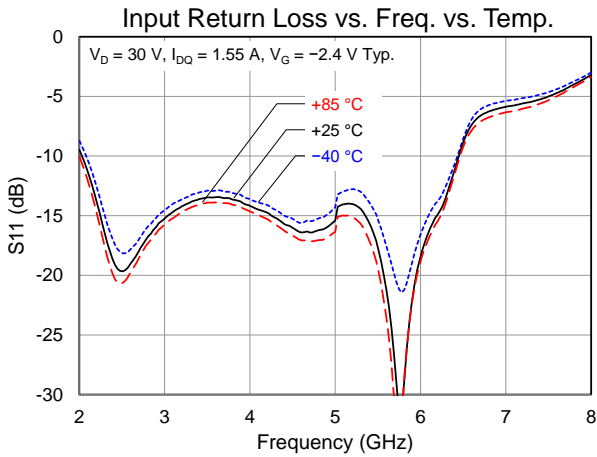
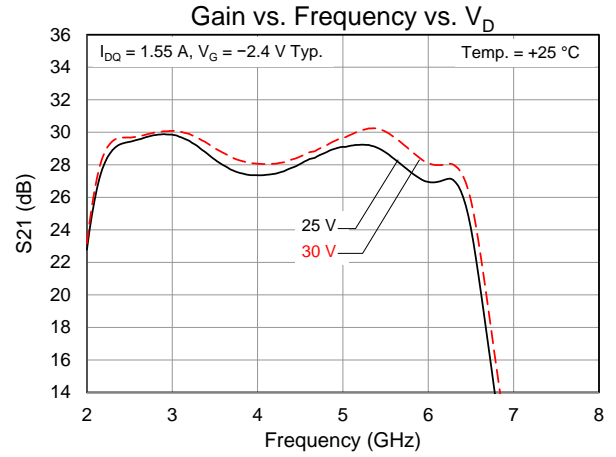
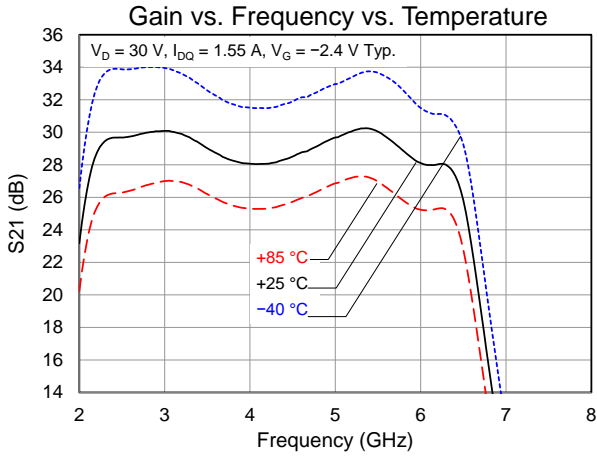
Temperature Derating T_{BASE} vs. $P_{OUT,AVG}$



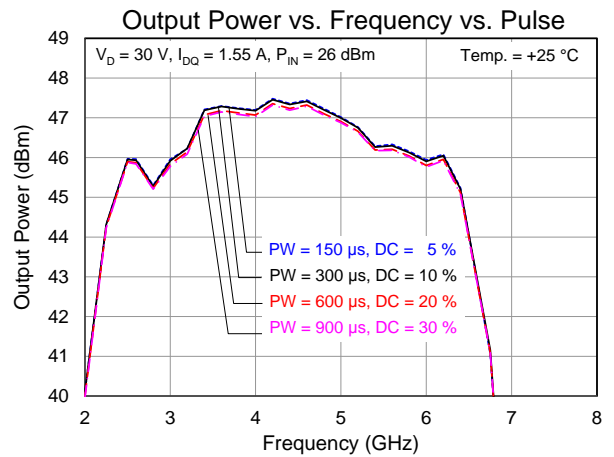
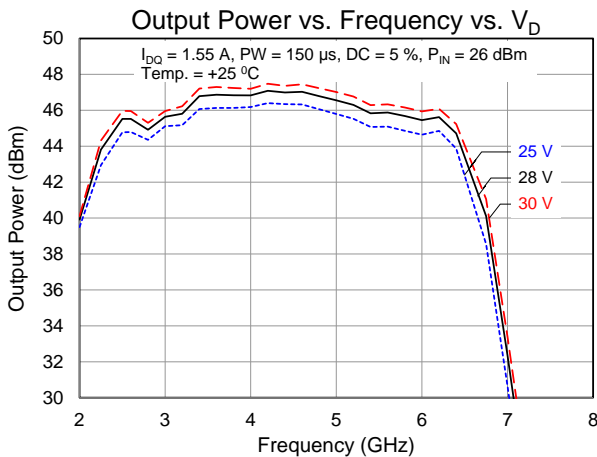
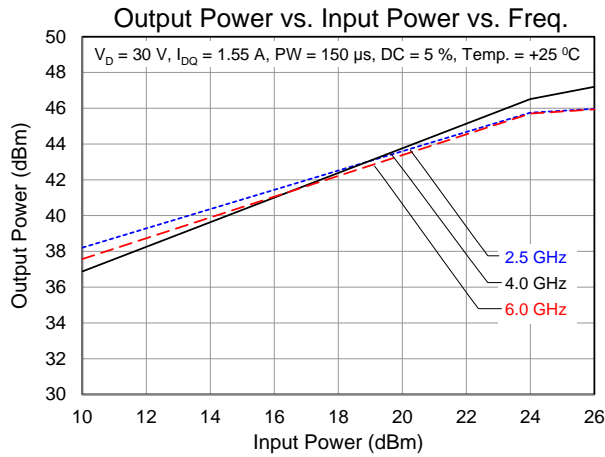
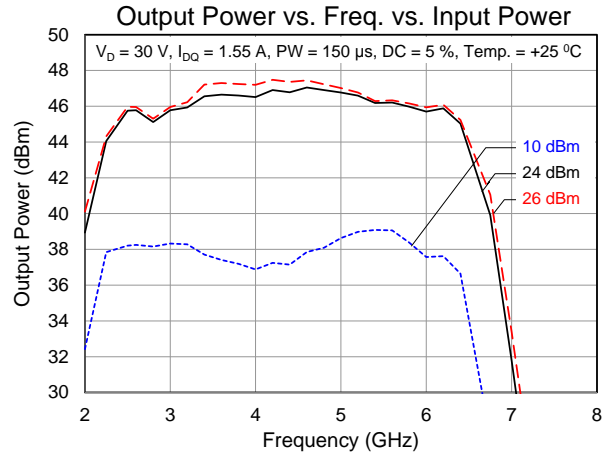
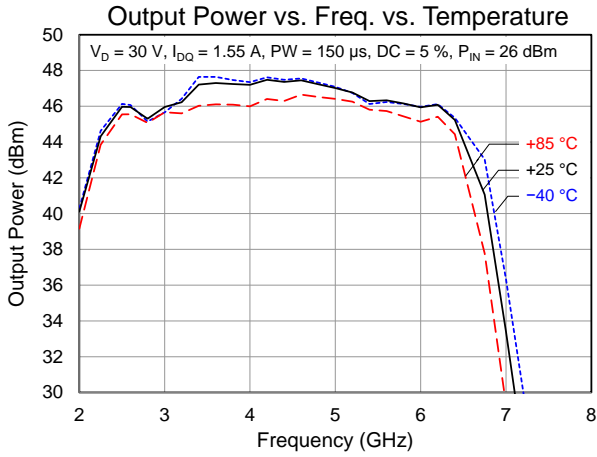
Thermal and Reliability Information (Con't.)



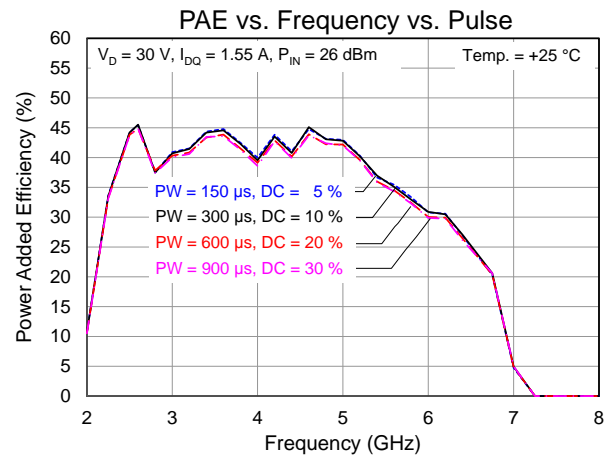
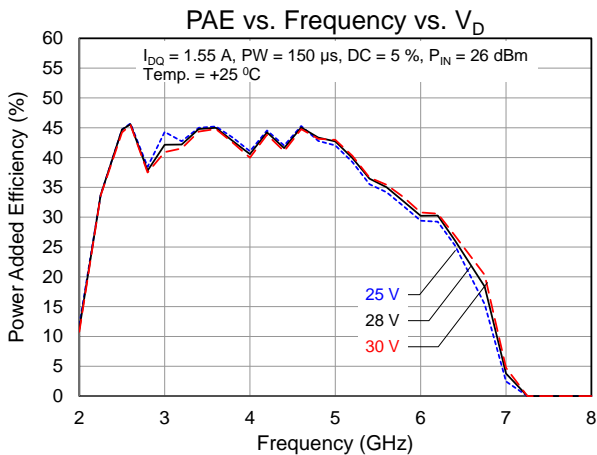
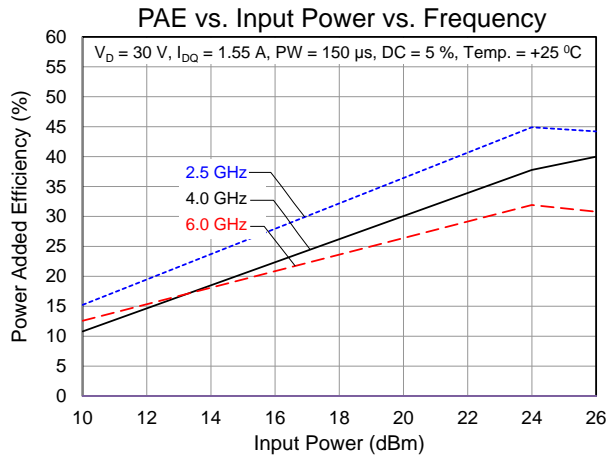
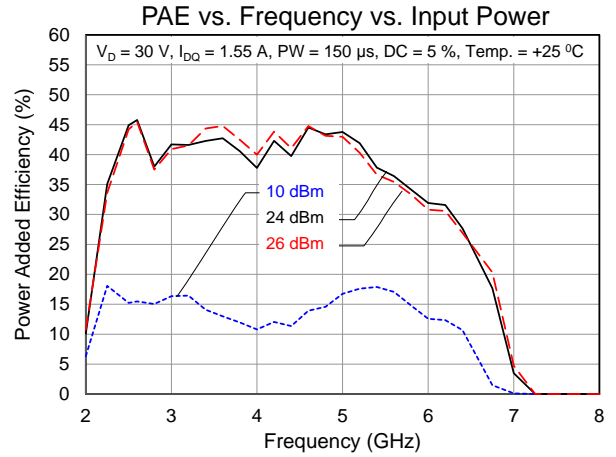
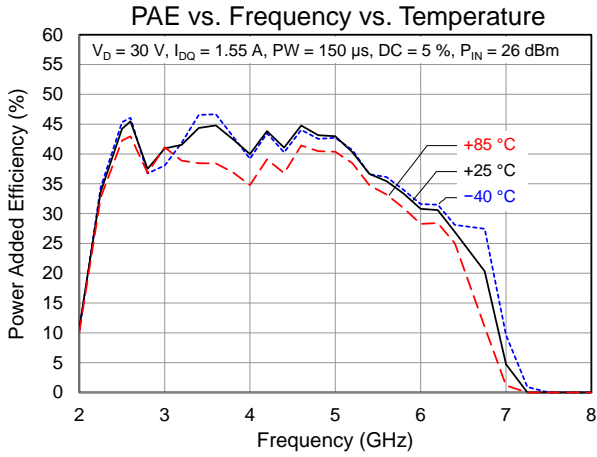
Typical Performance: Small Signal, CW



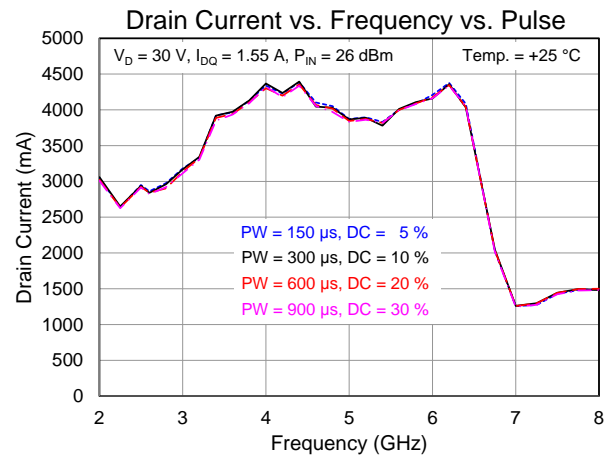
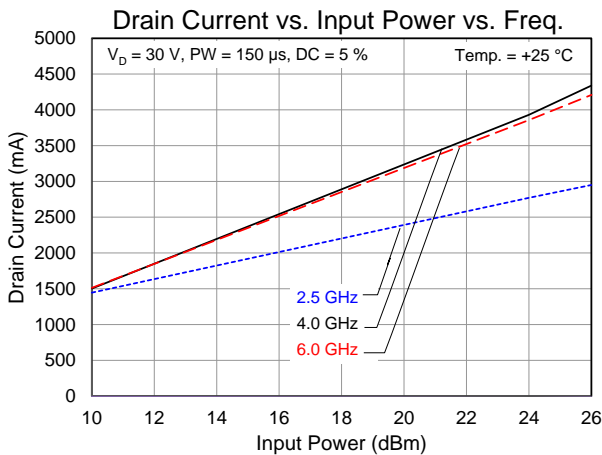
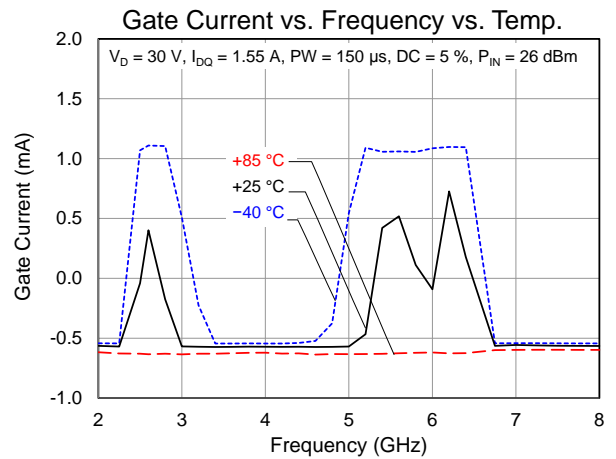
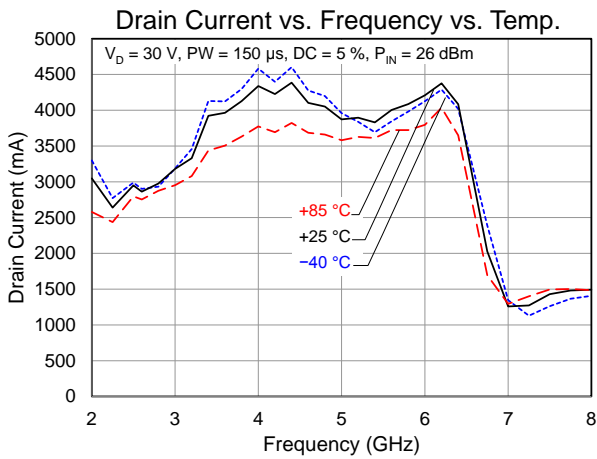
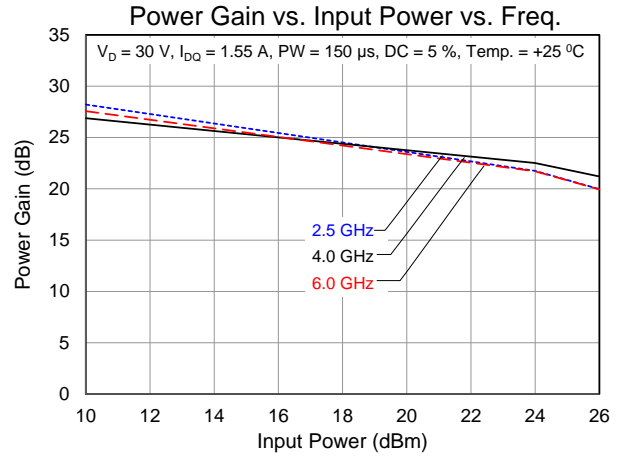
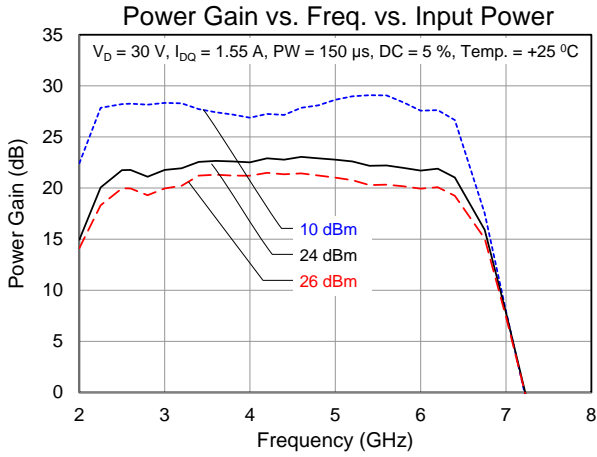
Typical Performance: Large Signal, Pulse



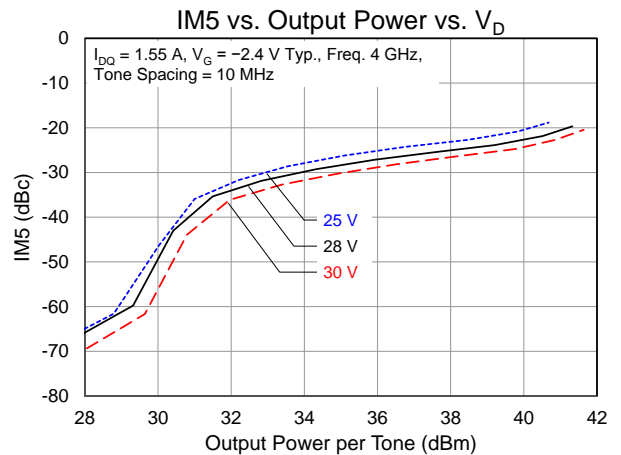
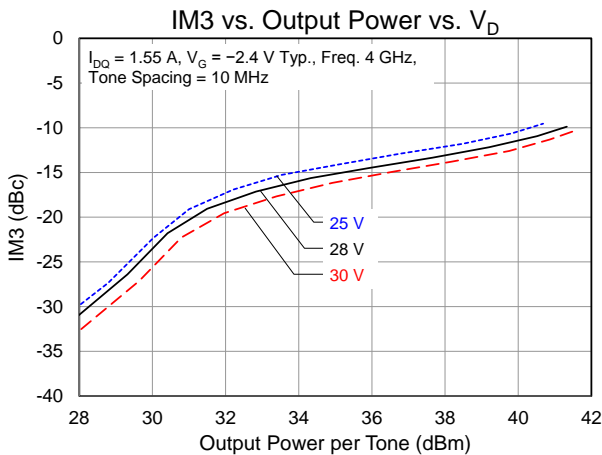
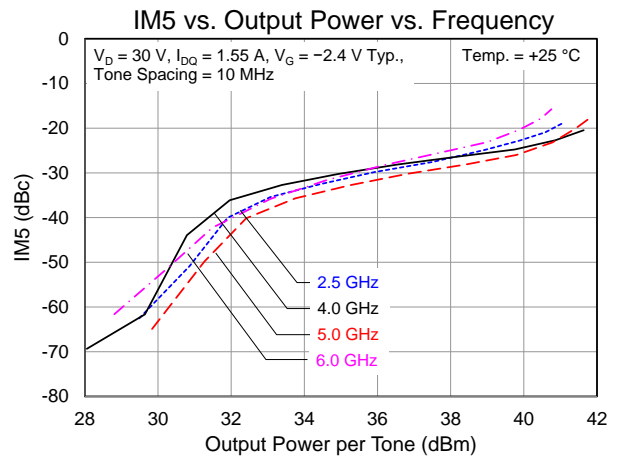
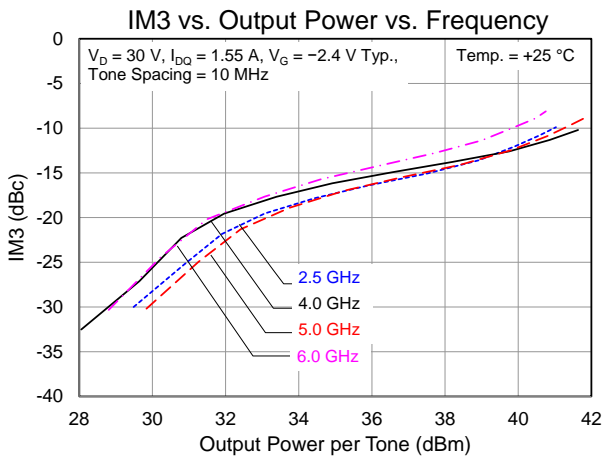
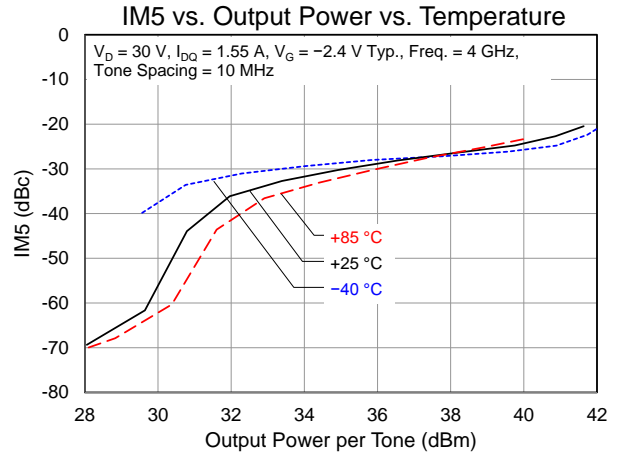
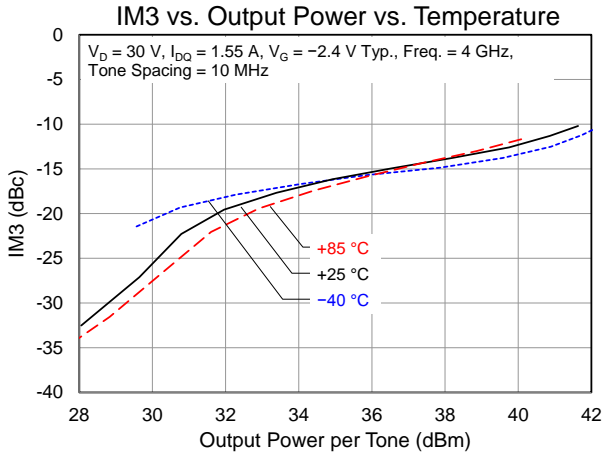
Typical Performance: Large Signal, Pulse



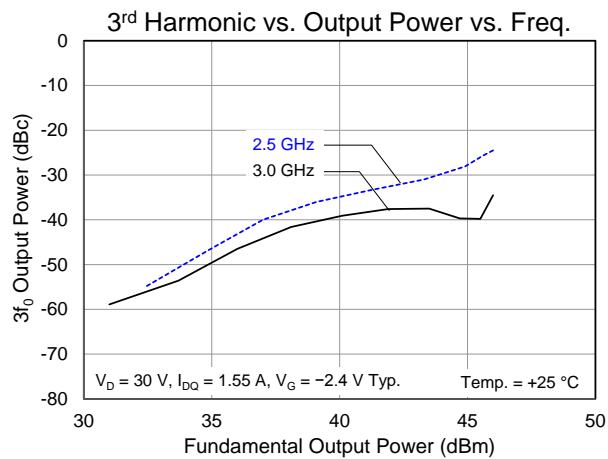
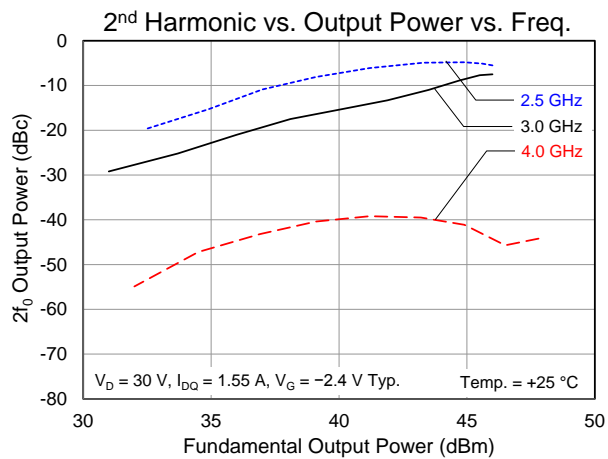
Typical Performance: Large Signal, Pulse



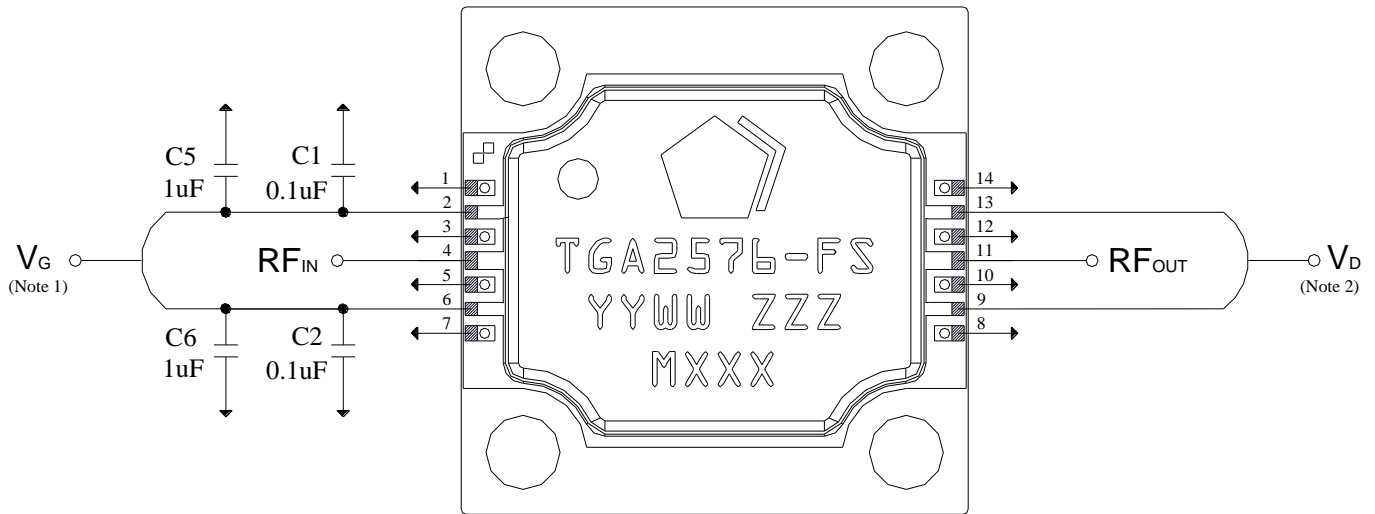
Typical Performance: Linearity, CW



Typical Performance (con't)



Application Circuit



Notes:

1. V_G can be biased from either side (Pins 2 or 6)
2. V_D must be biased from both sides (Pins 9 and 13)

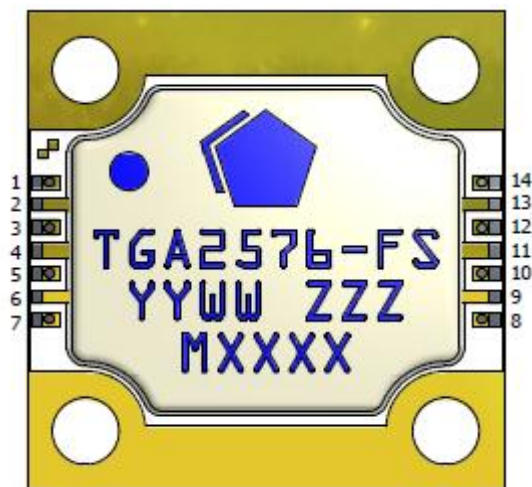
Bias-up Procedure

1. Set power supply: I_D limit to 5 A, I_G limit to 10 mA
2. Apply -5.0 V to V_G (for pinch-off)
3. Increase V_D to +30V; Ensure $I_{DQ} < 10$ mA
4. Adjust V_G more positive until $I_{DQ, PEAK} = 1.55$ A ($I_{DQ, AVG} = 77.5$ mA for 5% duty cycle); $V_G \sim -2.4$ V typ
5. Apply RF signal

Bias-down Procedure

1. Turn off RF signal
2. Reduce V_G to -5.0 V; Ensure $I_{DQ} \sim 0$ mA
3. Reduce V_D to 0 V or turn off the pulse generator to disable the V_D modulator
4. Turn off V_G supply

Pin Description

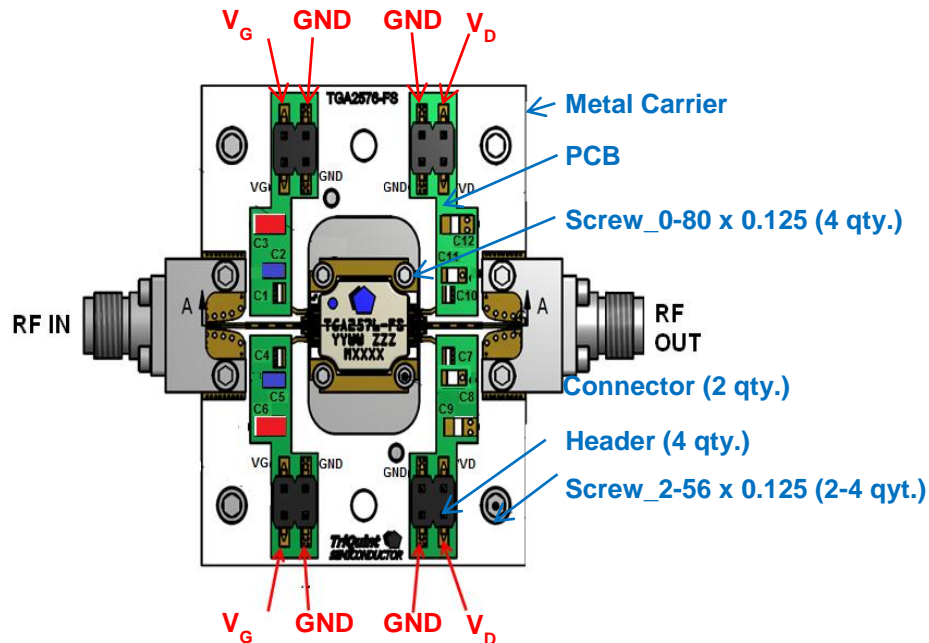


Pin	Symbol	Description
1, 3, 5, 7, 8,10, 12, 14	Gnd	Ground; may be grounded or left open on PCB.
2, 6	V_G	Gate voltage ⁽¹⁾
4	RF_{IN}	Input; matched to 50 Ω ; DC shorted to ground
9, 13	V_D	Drain voltage ⁽²⁾ ; Pulsed operation (not recommend for CW)
11	RF_{OUT}	Output; matched to 50 Ω ; DC shorted to ground
	Package Base	RF and DC ground.

Notes:

1. Bias network is required; can be biased from either side (Pins 2 or 6); see Application Circuit on page 11
2. Bias network is required; must be biased from both sides (Pins 9 and 13); see Application Circuit on page 11

Evaluation Board Layout



Bill of Material

Reference Des.	Value	Description	Manuf.	Part Number
Metal Carrier, PCB		Download file at: www.TriQuint.com/Products/p/TGA2576-FS	Various	
C2, C5	0.1 μ F	Cap, 0603, 50 V, 10%, X7R	Various	
C3, C6	1 μ F	Cap, 1206, 50 V, 10%, X7R	Various	

Recommended Assembly Evaluation Board

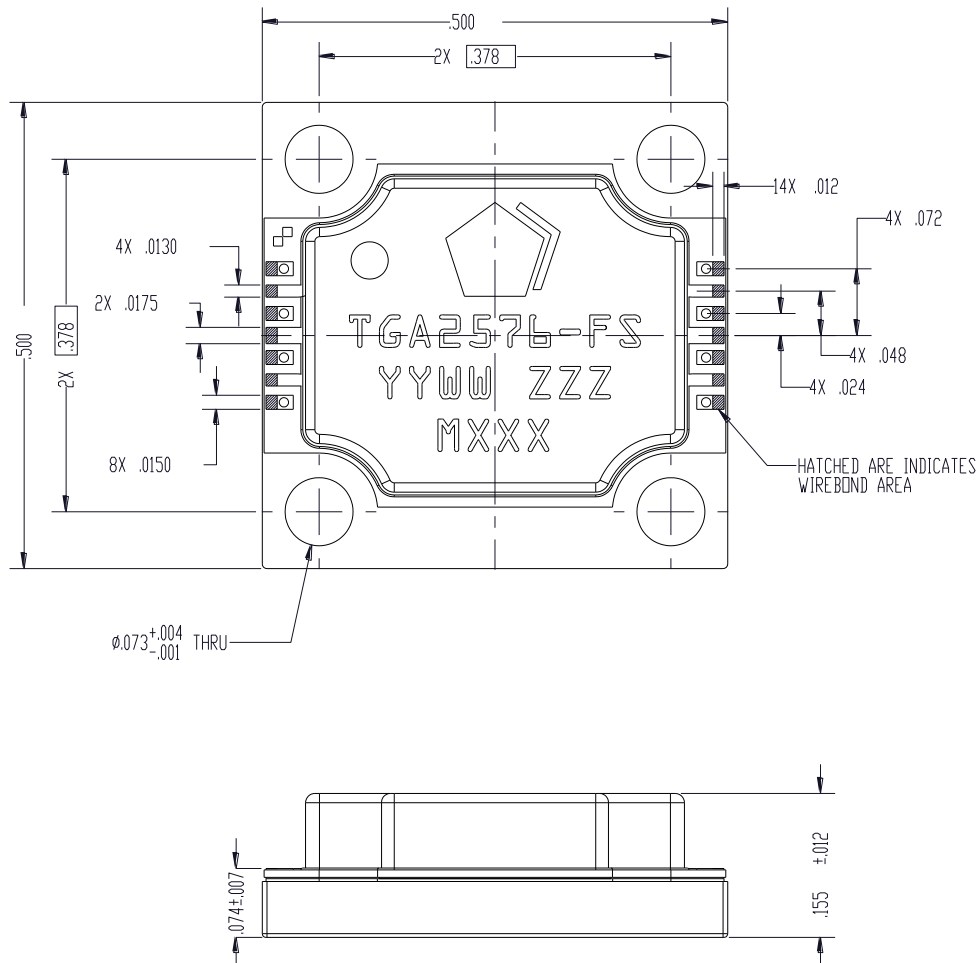
1. Attach PCB to carrier using film epoxy (i.e Ablefilm 5028E)
2. Attach TGA2576-FS to carrier using thermal compound or 4 mils indium shim and screws (0-80 x 0.125)
3. Bond two wires (0.001" dia.) from RF_{IN} (pin 4) to PCB; and three wires from RF_{OUT} (pin 11) to PCB; ensure bond wires as short as possible
4. Bond one wire (0.001" dia.) from V_G (pin 2 and/or pin 6) to PCB; and four wires from V_D (pin 9 and pin 13) to PCB; ensure bond wires as short as possible
5. Attach 2x2 headers (i.e C-146130 Tyco Electronics) using solder (i.e Sn62Pb35/AG2)
6. Attach connector (i.e SMA 1092-01A-5 Southwest Microwave) to clamp down PCB and carrier; launch connector pins needs to be aligned to PCB trace and to make contact to metal surface

Notes: to improve the thermal and thus RF performance, we recommend the following:

1. If using temperature-controlled cold-plate: mount Evaluation Board to cold-plate using screws (2-26 x 0.125) at the 4 corner mounting holes
2. If without cold-plate: attached a heat sink and fan to Evaluation Board using thermal compound or 4 mils indium shim and screws (2-26 x 0.125)
3. Slide a thermocouple into the hole on the side of carrier for monitoring package T_{BASE} (if desired); the temperature difference between thermocouple and T_{BASE} is appx. 10 °C typical (for \leq 20% duty cycle operation)

Mechanical Information

Marking:
 Part number: TGA2576-FS
 Year/Week/Serial number: YYWW ZZZ
 Batch ID: MXXX



Notes:

1. Unless specified otherwise, dimensions are in inches.
2. Unless specified otherwise, tolerances are ± 0.005
3. Materials:
 - Package base material: Copper (Cu)
 - Package base finish: Gold (Au) 50 uin min over Nickel (Ni) 200 uin min
 - Package lid: LCP (Liquid Crystal Polymer)
 - Bond Pads (hatched): Gold plate per ASTM B 488, Type III, Grade A, Class 1, 50 uin min

Product Compliance Information**ESD Sensitivity Ratings**

Caution! ESD-Sensitive Device

ESD Rating: Class 1B
Value: $\geq 500V$ and $< 1000V$
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

MSL Rating

Level 5a at +260 °C convection reflow
The part is rated Moisture Sensitivity Level 5a at 260°C per
JEDEC standard IPC/JEDEC J-STD-020.

ECCN

US Department of Commerce: 3A001.b.2.a

Solderability

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

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For technical questions and application information:

Email: info-products@triquint.com**Important Notice**

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Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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